

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	235	(118/501).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:17
L2	1433	(118/319,320).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:18
L3	1532	(118/326).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:19
L4	105	(156/345.54).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:28
L5	92	(156/345.55).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:28
L6	807	(438/758).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:29
L8	1913	(118/719).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:29
L10	1683	(134/153,157).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:30
L11	2335	(118/729-730).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:30
L12	170	(118/900,902).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:31

L13	19	2 and sump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:31
L14	10	1 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:45
L15	86	2 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:32
L16	35	3 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:32
L17	252	8 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:32
L18	146	10 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:33
L19	167	11 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:33
L20	17	12 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:33
L21	4949	(118/715).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/16 10:45

L22	449	7 and (semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:45
S2	176	(yewebdar or tadesse) and ("118"/\$.ccls. or "264"/\$.ccls.)	US-PGPUB; USPAT	OR	OFF	2005/03/08 10:01
S77	1	09/921840	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 14:47
S78	49	((("3,727,620") or ("3,953,265") or ("4,132,567") or ("4,439,243") or ("4,439444") or ("4,544,446") or ("4,664,133") or ("4,750,505") or ("4,790,262") or ("4,838,289") or ("4,903,717") or ("4,982,215") or ("4,982,753") or ("5,020,200") or ("5,032,217") or ("5,117,769") or ("5,168,886") or ("5,209,180") or ("5,222,310") or ("5,224,503") or ("5,224,504") or ("5,349,978"))).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/07 14:47
S79	22	((("3,727,620") or ("3,953,265") or ("4,132,567") or ("4,439,243") or ("4,439444") or ("4,544,446") or ("4,664,133") or ("4,750,505") or ("4,790,262") or ("4,838,289") or ("4,903,717") or ("4,982,215") or ("4,982,753") or ("5,020,200") or ("5,032,217") or ("5,117,769") or ("5,168,886") or ("5,209,180") or ("5,222,310") or ("5,224,503") or ("5,224,504") or ("5,349,978"))).PN.	US-PGPUB; USPAT	OR	OFF	2005/03/07 14:49
S80	24	((("5,361,449") or ("5,421,893") or ("5,431,421") or ("5,445,172") or ("5,513,594") or ("5,551,986") or ("5,591,262") or ("5,616,069") or ("5,666,985") or ("5,677,824") or ("5,678,116") or ("5,718,763") or ("5,762,708") or ("5,762,751") or ("5,779,796") or ("5,815,762") or ("5,845,662") or ("5,860,640") or ("5,868,866") or ("5,882,433") or ("5,885,755") or ("5,916,366") or ("5,942,035") or ("5,997,653"))).PN.	US-PGPUB; USPAT	OR	OFF	2005/03/07 14:50

S81	71	JP-1120023\$.did. JP-1283845\$.did. JP-494537\$.did. JP-513322\$.did. JP-5212576\$.did. JP-521332\$.did. JP-5326483\$.did. JP-59208831\$.did. JP-60137016\$.did. JP-61196534\$.did. JP-62166515\$.did. JP-63185029\$.did. JP-645302\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 15:44
S82	49	JP-1120023\$.did. JP-1283845\$.did. JP-494537\$.did. JP-513322\$.did. JP-5212576\$.did. JP-521332\$.did. JP-5326483\$.did. JP-59208831\$.did. JP-60137016\$.did. JP-61196534\$.did. JP-62166515\$.did. JP-63185029\$.did. JP-645302\$.did.	JPO	OR	OFF	2005/03/07 15:10
S83	22	JP-1120023\$.did. JP-1283845\$.did. JP-494537\$.did. JP-513322\$.did. JP-5212576\$.did. JP-521332\$.did. JP-5326483\$.did. JP-59208831\$.did. JP-60137016\$.did. JP-61196534\$.did. JP-62166515\$.did. JP-63185029\$.did. JP-645302\$.did.	DERWENT	OR	OFF	2005/03/07 14:55
S84	1	JP-10120023\$.did.	JPO	OR	OFF	2005/03/07 15:34
S85	0	JP-62277714\$.did.	JPO	OR	OFF	2005/03/07 15:34
S89	1	JP-11200230\$.did.	JPO	OR	OFF	2005/03/07 15:36
S90	1	JP-01200230\$.did.	JPO	OR	OFF	2005/03/07 15:37
S92	1	JP-62277714\$.did.	EPO; JPO; DERWENT	OR	OFF	2005/03/07 15:41
S94	0	JP-4494537\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 15:48
S96	1	S79 and sump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 15:49
S97	0	S80 and sump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 15:54
S98	818	(semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3) same collect\$3 near7 (fluid or resist or solution or liquid)same (recycl\$3 or return\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:07

S99	32	09/041901	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:51
S10 0	50	("3727620" "3953265" "4132567" "4439243" "4439244" "4544446" "4664133" "4750505" "4790262" "4838289" "4903717" "4982215" "4982753" "5020200" "5032217" "5117769" "5168886" "5209180" "5222310" "5224503" "5224504" "5298465" "5349978" "5361449" "5421893" "5431421" "5445172" "5474641" "5513594" "5551986" "5591262" "5616069" "5666985" "5677824" "5678116" "5706843" "5718763" "5762708" "5762751" "5779796" "5815762" "5845662" "5860640" "5868866" "5882433" "5885755" "5916366" "5942035" "5997653" "6077404").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/07 15:59
S10 1	52	S98 and "118"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:04
S10 2	2	S101 and sump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:05
S10 3	23	S99 and sump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:05
S10 4	36	(semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid)same (recycl\$3 or return\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 13:46
S10 5	9	(semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid)same (recycl\$3 or return\$3)same(edge or peripheral)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:12

S10 6	48	(semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid)same (edge or peripheral)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:39
S10 7	13	(semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid)same (edge or peripheral)and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 10:32
S10 8	4	("5254367" "5658615" "5695817" "5766671").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/07 16:23
S10 9	4	S108 and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:24
S11 0	98	(semiconductor\$1 or wafer\$1) and (fluid or resist or solution or liquid) same (edge or (peripheral near region)) near7 collect\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 17:08
S11 1	30	S110 and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:47
S11 2	3	S98 and(edge or (peripheral near region)) near7 collect\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:42
S11 3	16	S98 and(edge or (peripheral near region)) near7 chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:42
S11 4	7	("4890480" "4967782" "5330576" "5365778" "6048400" "6082180" "6527860").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/07 16:46

S11 5	2	S114 and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 16:49
S11 6	4	("5695817" "5762709" "5972078" "6284043").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/09 11:01
S11 7	2	S116 and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 17:08
S11 8	577	(semiconductor\$1 or wafer\$1) and chucks same chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 17:08
S11 9	16	(semiconductor\$1 or wafer\$1) and plurality near3 chucks same chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 09:33
S12 0	7	(semiconductor\$1 or wafer\$1) and plurality near3 chucks same process\$3 near chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/07 17:12
S12 1	2496	(118/50).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/08 08:39
S12 2	1436	(118/52).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/08 08:39
S12 3	394	(118/612).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/03/08 08:39

S12 4	0	S121 and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid) same (edge or peripheral)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:40
S12 5	11	S122 and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid) same (edge or peripheral)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:50
S12 6	0	S123 and (sump or trap or collect\$3) same cup near7 (fluid or resist or solution or liquid) same (edge or peripheral)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:40
S12 7	2	S125 and process\$3 near chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:45
S12 8	0	S125 and chambers	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:44
S12 9	2	S125 and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:45
S13 0	13	S122 and (plurality near3 chambers)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 08:51
S13 1	21	S122 and (plurality near3 (chucks or supports))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 10:15
S13 2	6	("5374312" "5571560" "5772764" "5945161" "5962070" "5972426"). PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/08 09:05

S13 4	20	jp-1022547\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 09:17
S13 5	2	jp-10022547\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 09:17
S13 6	191	(semiconductor\$1 or wafer\$1) and plurality near3 chucks	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/08 09:33
S14 0	819	(semiconductor\$1 or wafer\$1) and (sump or trap or collect\$3) same collect\$3 near7 (fluid or resist or solution or liquid)same (recycl\$3 or return\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:52
S14 1	4	("5254367" "5658615" "5695817" "5766671").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/09 11:11
S14 2	4	S141 and chamber	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:04
S14 3	0	S140 and S142	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:04
S14 4	1	"5254367" and "5658615" and "5695817" and "5766671"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/09 11:06
S14 5	0	S141 and chamber same cup same collect\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:12

S14 6	1	S141 and chamber same cup	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:12
S14 7	9	("3727620" "4982753" "5445172" "5500081" "5551986" "6139639" "6264752" "6350319" "6423642"). PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/09 11:27
S14 8	89	curtis-gary\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 13:03
S14 9	179	thompson-raymon\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 13:35
S15 0	64	(semiconductor\$1 or wafer\$1) and S148	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 11:53
S15 1	95	(semiconductor\$1 or wafer\$1) and S149	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 13:03
S15 2	78	curtis-gary\$.in.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/09 13:03
S15 3	59	(semiconductor\$1 or wafer\$1) and S152	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 13:35
S15 4	160	thompson-raymon\$.in.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/09 13:35
S15 5	86	(semiconductor\$1 or wafer\$1) and S154	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/09 13:37

S15 6	1476	(plurality near3 (chucks or supports)) same stack\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 10:25
S15 7	117	(semiconductor\$1 or wafer\$1) and S156	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 10:21
S15 8	15	(plurality near3 (chucks)) same stack\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 10:39
S15 9	5	("5100502" "5954072" "5989342" "6052913" "6222991").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/15 10:30
S16 0	20	(plurality near7 (chucks)) same stack\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 10:40
S16 1	12	("3982627" "4892455" "5183378" "5382806" "5533243" "5648854" "5759007" "5853284" "6027301" "6203268" "6222339" "6270307"). PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/15 10:44
S16 2	3	08/847721	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 10:44
S16 3	9	("3727620" "4982753" "5445172" "5500081" "5551986" "6139639" "6264752" "6350319" "6423642"). PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/15 11:05
S16 4	5	S163 and rotor\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 11:05

S16 6	2	09/921845	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 11:33
S16 7	2	09/921839	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 11:33
S16 8	3236	(semiconductor\$1 or wafer\$1) and rotating same (housing or chamber) same motor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 13:47
S16 9	558	(semiconductor\$1 or wafer\$1) and rotating near5(housing or chamber) same motor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 13:48
S17 0	362	(semiconductor\$1 or wafer\$1) and rotating near5(housing) same motor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 13:49
S17 1	249	(semiconductor\$1 or wafer\$1) and rotating near3(housing) same motor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 13:49
S17 2	92	("3727620").URPN.	USPAT	OR	OFF	2005/03/15 15:44
S17 3	12	"5980195"	USPAT	OR	OFF	2005/03/15 15:51
S17 4	1	process\$3 near5 chamber same stack\$3 same wafer same chucks	USPAT	OR	OFF	2005/03/15 15:50
S17 5	1	process\$3 near5 chamber same stack\$3 same wafer\$1 same chucks	USPAT	OR	OFF	2005/03/15 15:50
S17 6	4	chamber same stack\$3 same wafer same chucks	USPAT	OR	OFF	2005/03/15 15:51
S17 7	14	("5162047" "5445486" "5479108" "5549444" "5565034" "5636964" "5647626" "5655871" "5669644" "5669752" "5700046" "5711646" "5711647" "5851102").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/15 15:52